

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: BELLMAN ROBERT A, et al

Examiner: Unknown

Serial No: 10/632363

Group Art Unit: Unknown

Filed: 7/31/2003

For: HARD PELLICLE AND FABRICATION  
THEREOFINFORMATION DISCLOSURE STATEMENT  
UNDER 37 C.F.R. §§ 1.56, 1.97 – 1.98Commissioner of Patents  
Alexandria, VA 22313-1450

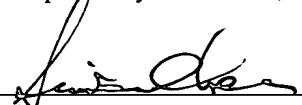
Dear Sir:

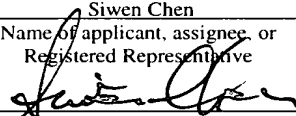
The Examiner's attention is hereby directed to the following reference(s) listed on the attached Form PTO-1449 for consideration in connection with the examination of the above-identified patent application. One copy of the reference(s) is enclosed.

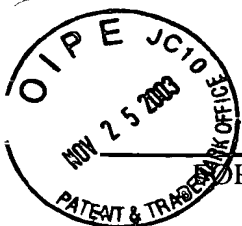
This submission does not represent that a search has been made or that no better art exists and does not constitute an admission that each or all of the enclosed documents constitute "prior art." If it should be determined that any of the submitted documents do not constitute "prior art" under United States law, applicant(s) reserve the right to present to the office the relevant facts and law regarding the appropriate status of such documents.

Applicant(s) further reserve the right to take appropriate action to establish the patentability of the disclosed invention over the enclosed references, should one or more of the references be applied against the claims of the present application.

Respectfully submitted,

  
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607-248-1253Date: Nov. 21, 2003

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to Commissioner of Patents, Alexandria, Va 22313-1450 on	
<u>Nov. 21, 2003</u>	Date of Deposit
Siwen Chen Name of applicant, assignee, or Registered Representative	
	Signature
<u>Nov. 21, 2003</u>	Date of Signature



FORM PTO-1449 (MODIFIED)

ATTORNEY DOCKET NO.

SERIAL NO.

LIST OF PATENTS AND  
PUBLICATIONS  
FOR APPLICANTS INFORMATION  
DISCLOSURE STATEMENT

SP03-102

10/632363

APPLICANT: BELLMAN ROBERT A, et al.

FILING DATE 7/31/2003

GROUP: Unknown

REFERENCE DESIGNATION

U.S. PATENT DOCUMENTS

Examiner Initial		Document Number	Date	Name	Class	Sub-Class	Filing Date if Approp.
	AA	2001/0024701	9/27/01	Matsukura et al	428	14	3/13/01
	AB	2002/0127477	9/12/02	Levinson et al	430	5	1/26/01
	AC	2003/0035222	2/20/03	Okada et al	359	629	7/29/02
	AD	6,475,575	11/5/02	Ikuta et al	428	14	
	AE	6,524,754	2/25/03	Eynon	430	5	1/22/01
	AF	6,544,693	4/8/03	Levinson et al	430	5	1/26/01
	AG						
	AH						

FOREIGN PATENT DOCUMENTS

		Document Number	Date	Country	Class	Sub-Class	Translation Yes	No
	AI	EP1154320	11/14/01	Europe	G03F	1/14	X	
	AJ	8-160597	6/21/96	Japan	G03F	1/08		X
	AK							

OTHER ART (Including Author, Title, Date, Pertinent Pages, etc.)

	AL	Julian Blake; "Simox (Separation by Implantation of Oxygen); Encyclopedia of Physical Science and Technology; Third Edition; Volume 14; July 2001; pages 805-813
	AM	Bruel et al; "Smart Cut: A Promising New Soi Material Technology"; IEEE International SOI Conference; Oct. 1995; pages 178-179.
	AN	Maleville et al.; "Multiple SOI Layers by Multiple Smart-Cut Transfers"; IEEE International SOI Conference; Oct. 2000; pages 134-135.
	AO	Moriceau et al.; "Cleaning and Polishing as Key Steps for Smart-Cut SOI Process"; IEEE International SOI Conference; Oct. 1996, pages 152-153.
	AP	Stefan Bengtsson; "Wafer Bonding and Smartcut for Formation of Silicon-On-Insulator Materials"; IEEE; 1998; pages 745-748.
	AQ	Gosele et al.; "Wafer Bonding: An Overview"; Proceedings of 4th International Conference on Solid-State and IC Technology; 1995; pages 243-247
	AR	Gosele et al.; "Semiconductor Wafer Bonding"; IEEE; 1997; pages 23-32

EXAMINER:

DATE CONSIDERED:

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609: draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.